DSC5501

Silicon NPN epitaxial planar type

For low frequency amplification DSC2501 in SMini3 type package

■ Features

- Low collector-emitter saturation voltage V_{CE(sat)}
- Contributes to miniaturization of sets, reduction of component count.
- Eco-friendly Halogen-free package

Packaging

Embossed type (Thermo-compression sealing): 3000 pcs / reel (standard)

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Collector-base voltage (Emitter open)	V _{CBO}	25	V	
Collector-emitter voltage (Base open)	V _{CEO}	20	V	
Emitter-base voltage (Collector open)	V_{EBO}	12	V	
Collector current	I_{C}	0.5	A	
Peak collector current	I_{CP}	1	A	
Collector power dissipation	P _C	150	mW	
Junction temperature	T_j	150	°C	
Storage temperature	T _{stg}	-55 to +150	°C	

■ Package

- Code
 - SMini3-F2-B
- Pin Name
 - 1. Base
 - 2. Emitter
 - 3. Collector

■ Marking Symbol: E3

■ Electrical Characteristics $T_a = 25$ °C±3°C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	V _{CBO}	$I_C = 10 \mu A, I_E = 0$	25			V
Collector-emitter voltage (Base open)	V _{CEO}	$I_{\rm C} = 1 \text{ mA}, I_{\rm B} = 0$	20			V
Emitter-base voltage (Collector open)	V _{EBO}	$I_E = 10 \mu A, I_C = 0$	12			V
Collector-base cutoff current (Emitter open)	I _{CBO}	$V_{CB} = 25 \text{ V}, I_{E} = 0$			100	nA
Forward current transfer ratio *2	h_{FE}	$V_{CE} = 2 \text{ V}, I_{C} = 0.5 \text{ A}$	200		800	_
Collector-emitter saturation voltage *1	V _{CE(sat)}	$I_{\rm C} = 0.5 \text{A}, I_{\rm B} = 20 \text{mA}$		0.18	0.40	V
Base-emitter saturation voltage *1	V _{BE(sat)}	$I_{\rm C} = 0.5 \text{A}, I_{\rm B} = 50 \text{mA}$			1.2	V
Transition frequency	f_T	$V_{CE} = 10 \text{ V}, I_{C} = 50 \text{ mA}$		150		MHz
Collector output capacitance (Common base, input open circuited)	C _{ob}	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		6		pF
ON resistance *3	R _{on}			1.0		Ω

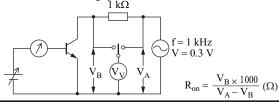
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

- 2. *1: Pulse measurement
 - *2: Rank classification

Code	R	S	Т	0
Rank	R	S	Т	No-rank
$h_{ m FE}$	200 to 350	300 to 500	400 to 800	200 to 800
Marking Symbol	E3R	E3S	E3T	E3

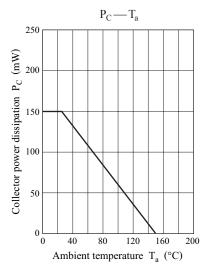
Product of no-rank is not classified and have no marking symbol for rank. *2. R measurement circuit 1 k Ω

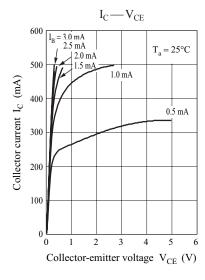
*3: Ron measurement circuit

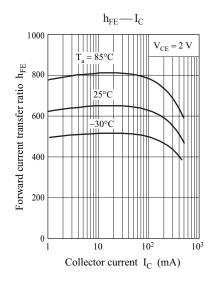


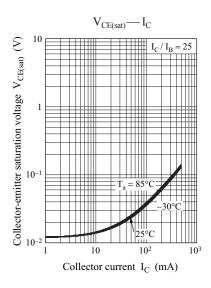
DSC5501

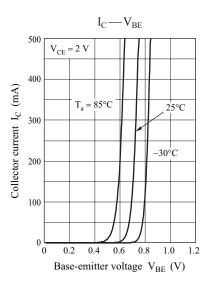
Panasonic

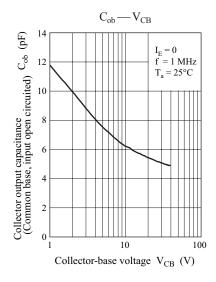


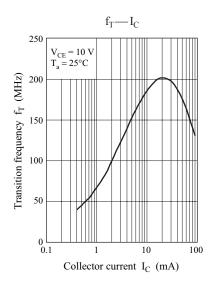


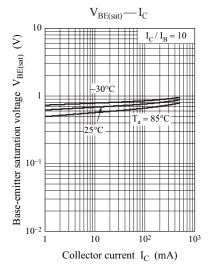










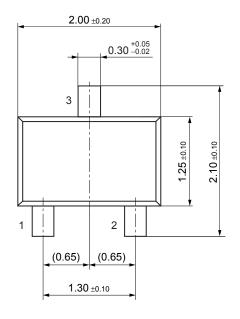


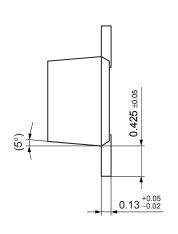
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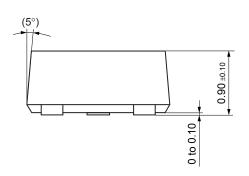
Panasonic DSC5501

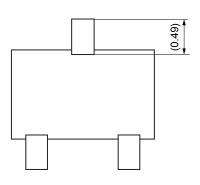
SMini3-F2-B

Unit: mm









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